Contact Name   Title - Contact   Phone - Contact*   Email - Contact*	IPC ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with low level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
Company name* Company name* Company unique ID  Unique ID Authority  Description  De	752-21.1										Materia	als and Mi	g Informati	on		
Insemi In	upplier Informa	tion														
Title - Contact Name Product-Env-Stewards Product-	Company name*				Company unique ID			Unique ID Authority					Response Date*			
Product-Env-Stewards Uthorized Representative* Title - Representative Product Enviro Compliance NA Product-Env-Stewards@onsemi.com Product-Env-Stewards@onsemi.com Product-Env-Stewards Product-Env-Stewards@onsemi.com NA Product-Env-Stewards@onsemi.com NA Product-Env-Stewards@onsemi.com Product-Env-Stewards@onsemi.com NA Product-Env-Stewards@onsemi.com Product-Env-Stewards@onsemi.com NA Product-Env-Stewards@onsemi.com NA Product-Env-Stewards@onsemi.com Product-Env-Stewards@onsemi.com NA Product-Env-Stewards@onsemi.com NA Product-Env-Stewards@onsemi.com NA Product-Env-Stewards@onsemi.com NA Product-Env-Stewards@onsemi.com NA	nsemi								2				2023-06-08			
Title - Representative Product Enviro Compliance NA Product-Env-Stewards Onsemi.com Requester Item Number Mfr Item Number Mfr Item Name Effective Date Version Manufacturing Site Weight* UOM U  CNY17F2VM 6PW NO-B TR DIP VDE 2023-06-08 LITEONFG 445.072 mg E  Manufacturing Proccess Information  Terminal Plating / Grid Array Material Terminal Base Alloy J-STD-020 MSL Rating Mate Tin (Sn) - annealed CU Alloy NA 0 C 30 seconds 3	Contact Name				Title - Contact			Phone - Contact*					Email - Contact*			
Product-Env-Stewards Requester Item Number Mfr Item Number Mfr Item Name Effective Date Version Manufacturing Site Weight* UOM U  CNY17F2VM 6PW NO-B TR DIP VDE 2023-06-08 LITEONFG 445.072 mg E  Manufacturing Proccess Information  Terminal Plating / Grid Array Material Terminal Base Alloy Terminal Plating / Grid Array Material Terminal Base Alloy NA 0 C 30 Seconds 3	roduct-Env-Steware	ds	Product Enviro Compliance			]	NA					Product-Env-Stewards@onsemi.com				
Requester Item Number	uthorized Represent	tative*	Title - Representative			I	Phone - Representative*					Email - Representative*				
CNY17F2VM 6PW NO-B TR DIP VDE 2023-06-08 LITEONFG 445.072 mg E    Internation   Control of the c	roduct-Env-Steward	ds	Product Enviro Compliance			1	NA					Product-Env-Stewards@onsemi.com				
Terminal Plating / Grid Array Material   Terminal Base Alloy   J-STD-020 MSL Rating   Peak Process Body Temperature   Max Time at Peak Temperature   Number of Reflow Cycles	Requester	Item Number	Mfr Item	Number	Mfr Item Name			Effective Date	e Vei	rsion	Manufacturing	Site	V	Veight*	UOM	Unit Type
Terminal Plating / Grid Array Material Terminal Base Alloy J-STD-020 MSL Rating Peak Process Body Temperature Max Time at Peak Temperature Number of Reflow Cycles  Matte Tin (Sn) - annealed CU Alloy NA 0 C 30 seconds 3			CNY17F2	2VM	6PW NO-B TR D	IP VDE		2023-06-08			LITEONFG		4	45.072	mg	Each
Matte Tin (Sn) - annealed CU Alloy NA 0 C 30 seconds 3				. 10		GTTD 020 Mg/		D 1 D		1 77	) ( m			N	CD CL	,
France III (01) unimented to those the seconds to	8 - 1 m m			, , , , , , , , , , , , , , , , , , ,			L Rating	Ĭ						er of Reflow Cyc	eles	
omments		(Sn) - annealed		U Alloy	l N	NA .		0		[C	30		secono	IS   3		
	omments															
or more information regarding material composition please refer to page 3			•.•	1 6 :												

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

<b>Homogeneous Material</b>	Weight	Weight Unit of Measure Level Substance		Substance	CAS	Exempt	Weight	Unit of Measure
Coupling Gel	0.4	mg	Supplier	Dimethyl Cyclosiloxanes	69430-24-6		0.04	mg
			Supplier	Trimethoxy(methyl)silane (C4H12O3Si)	1185-55-3		0.36	mg
Die	0.37	mg	Supplier	lier Silicon (Si)			0.37	mg
Die Attach	0.3	mg	Supplier	Silver (Ag)	7440-22-4		0.246	mg
			Supplier	Dicyandiamine	461-58-5		0.003	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.051	mg
Die GaAs	0.11	mg	В	Gallium Arsenide (AsGa)	1303-00-0		0.11	mg
Lead Frame	108.322	mg	Supplier	Silver (Ag)	7440-22-4		0.68	mg
			Supplier	Zinc (Zn)	7440-66-6		0.13	mg
			Supplier	Iron (Fe)	7439-89-6		2.48	mg
			Supplier	Copper (Cu)	7440-50-8		105	mg
			Supplier	Phosphorus (P)	7723-14-0		0.032	mg
Mold Compound-White	327.22	mg	Supplier	Titanium Dioxide (TiO2)	13463-67-7		81.805	mg
			В	Brominated Bisphenol A Diglycidyl Ether	40039-93-8		9.8166	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		44.1747	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		9.8166	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		163.61	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		17.9971	mg
Plating	6.7	mg	Supplier	Tin (Sn)	7440-31-5		6.7	mg
Wire Bond - Au	1.65	mg	Supplier	Gold (Au)	7440-57-5		1.65	mg